nexperia

Quarterly Reliability Monitoring Results

Quarters: Q1/2021 to Q4/2021

Based on structural	similarity
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Supplier		User Part Number						
Nexperia B.V.		PESD2USB5UX-T						
Name of Laboratory Assembly reliability labs		Part Description						
		NXP ICN8	Protection IND	DI				
		SMD package						
Based on A	AEC-Q101 Test	Test Conditions	Duration	# Lots	# Quantity	# Rejects		
	TEST							
	Pre- and Post-Stress							
# E1	Electrical Test	Tamb = 25 °C	N/A	see below	all parts	see below		
		JESD22-A113	24 h a					
	PC	Bake Tamb = 125 °C Soak Tamb = 85 °C, RH = 85%	24 hours 168 hours					
# A1	Preconditioning	Reflow soldering	3 cycles	286	21480	0		
,,,,,,	j	MIL-STD-750-1	,	200	21100	0		
	HTRB	M1038 Method A						
		Tj = Tjmax, Vr = 100% of max. datasheet						
# B1	Bias	reverse voltage	1000 hours	18	1440	0		
	тс	JESD22-A104						
# A4	Temperature Cycling	-65 °C to Tjmax, not to exceed 150°C	1000 cycles	86	6880	0		
		JESD22-A102						
	AC	Tamb = 121 °C, RH = 100 %						
# A3 alt	Autoclave	Pressure = 205 kPa (29.7 psia)	96 hours	86	6880	0		
	H3TRB	JESD22-A101 Tamb = 85 °C, RH = 85%, VR = 80 % of						
# 40 alt	High Humidity High Temperature Reverse Bias		1000 hours	96	6990	0		
# A2 alt	Temperature Reverse blas		1000 hours	86	6880	0		
	IOL	MIL-STD-750 Method 1037 ton = toff, devices powered to insure ΔT_j =						
# A5	Intermittent Operating Life		1000 hours	n.a.	n.a.	n.a.		
- AJ			1000 110015	a.	a.	n.a.		
	RSH	JESD22-A111						
# C8	Resistance to Solder Heat		10 s	28	840	0		
	SD			-		-		
# C10	Solderability	J-STD-002		36	360	0		

[1] The maximum applied voltage is limited by test chamber set up and does not exceed 115V.

Calculation of FIT and MTTF

Test considered for FIT calculation: High Temperature Reverse Bias (HTRB, Test #B1) Confidence level 60%, derated to 55 °C, activation energy 0.7 eV, test time 168 to 1000 hours

NXP ICN8 Protection INDI 1440 0 2.95 3.39E+08	Wafer Fab	Technology	Quantity	Rejects	Failure Rate (FIT)	MTTF (hrs)
	NXP ICN8	Protection INDI	1440	0	2.95	3.39E+08

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